

1. General description

Silicon Carbide Schottky diode in a TO220F-2L plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- New 6th Generation Technology
- Low Forward Voltage Drop
- Low Reverse Leakage Current
- High Forward Surge Capability I_{FSM}
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- Insulated package rated at 2500V RMS

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

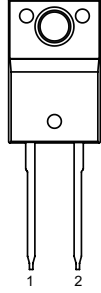
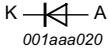
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute maximum rating							
V_{RRM}	repetitive peak reverse voltage			650			V
$I_{F(AV)}$	average forward current	$\delta = 0.5$; square-wave pulse; Fig. 1 ; Fig. 2 ; Fig. 3		16			A
T_j	junction temperature			-55 to 175			°C
Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V_F	forward voltage	$I_F = 16\text{ A}$; $T_j = 25\text{ °C}$; Fig. 5		-	1.29	1.45	V
		$I_F = 16\text{ A}$; $T_j = 150\text{ °C}$; Fig. 5		-	1.45	1.65	V

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	A	anode		
mb	n.c.	mounting base; isolated		

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WNSC6D16650X	TO220F-2L	WNSC6D16650X6Q	Tube	50	TO220FE-2L	21-Dec-2020

7. Marking

Table 4. Marking codes

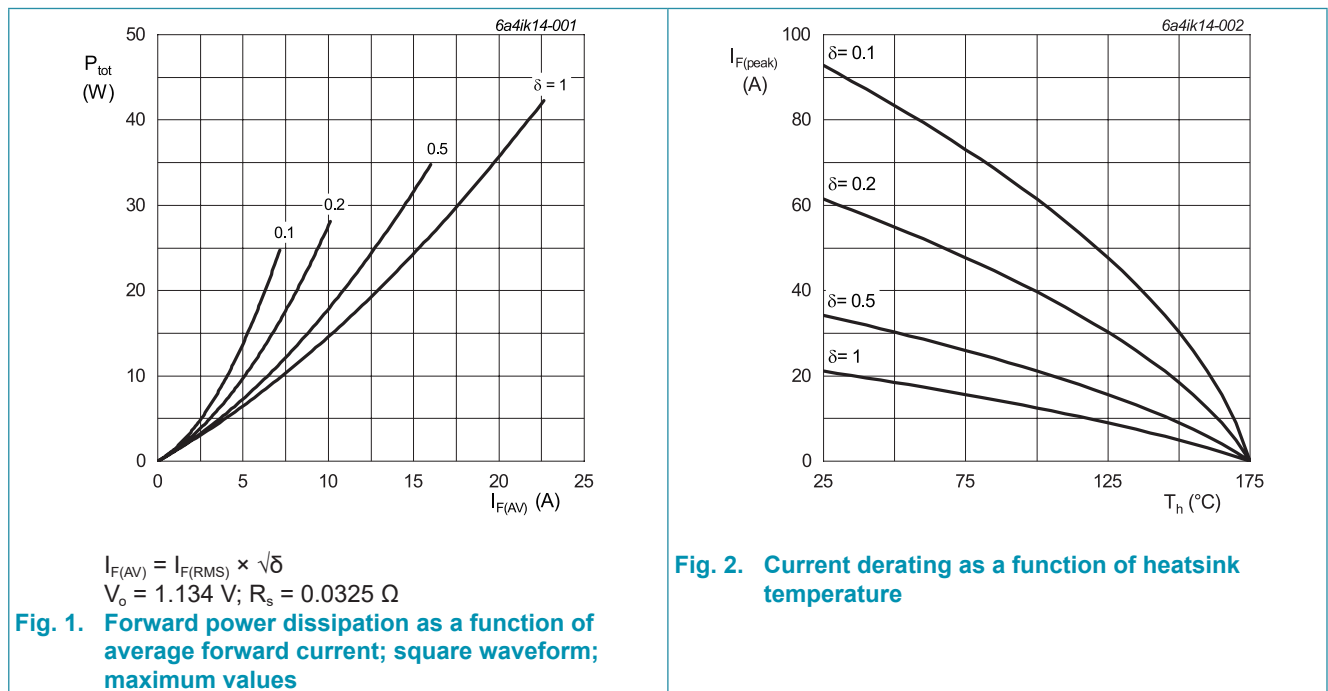
Type number	Marking codes
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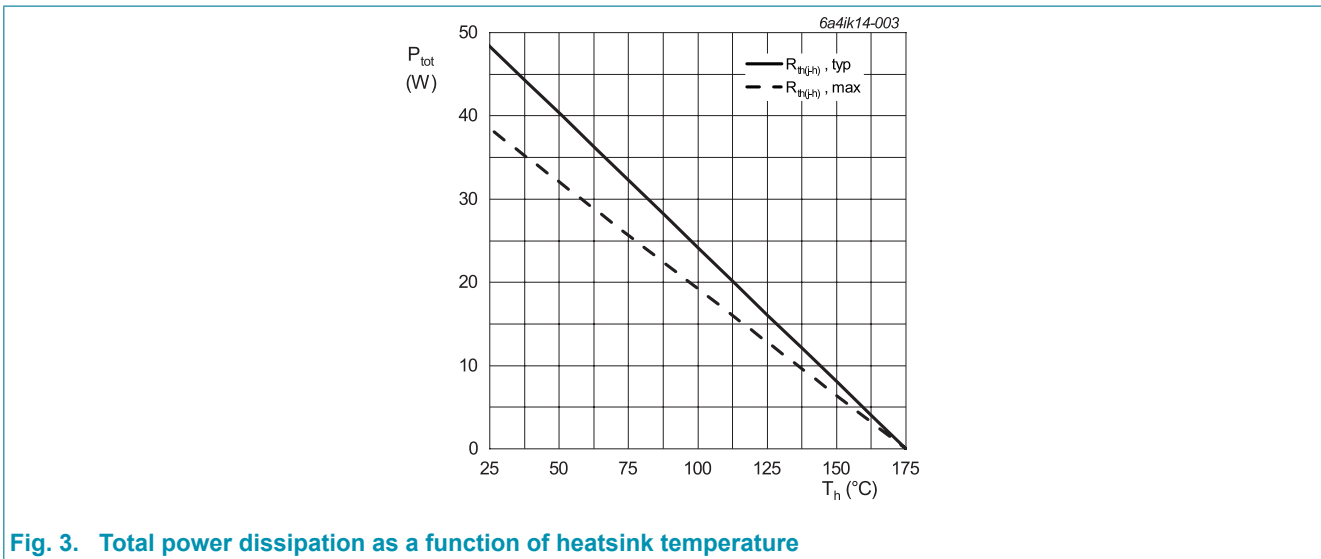
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{RRM}	repetitive peak reverse voltage			650	V
V_{RWM}	crest working reverse voltage			650	V
V_R	reverse voltage	DC		650	V
$I_{F(AV)}$	average forward current	$\delta = 0.5$; square-wave pulse; Fig. 1 ; Fig. 2 ; Fig. 3		16	A
I_{FRM}	repetitive peak forward current	$\delta = 0.5$; $t_p = 25 \mu s$; square-wave pulse		32	A
I_{FSM}	non-repetitive peak forward current	$t_p = 10 ms$; $T_{j(init)} = 25 \text{ }^\circ\text{C}$; sine-wave pulse		100	A
		$t_p = 10 \mu s$; $T_{j(init)} = 25 \text{ }^\circ\text{C}$; square-wave pulse		900	A
I^2t	I^2t for fusing	$t_p = 10 ms$; $T_{j(init)} = 25 \text{ }^\circ\text{C}$; sine-wave pulse		50	A^2s
T_{stg}	storage temperature			-55 to 175	$^\circ\text{C}$
T_j	junction temperature			-55 to 175	$^\circ\text{C}$





9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$R_{th(j-h)}$	thermal resistance from junction to heatsink	with heatsink compound; Fig. 4		-	3.1	3.9	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W

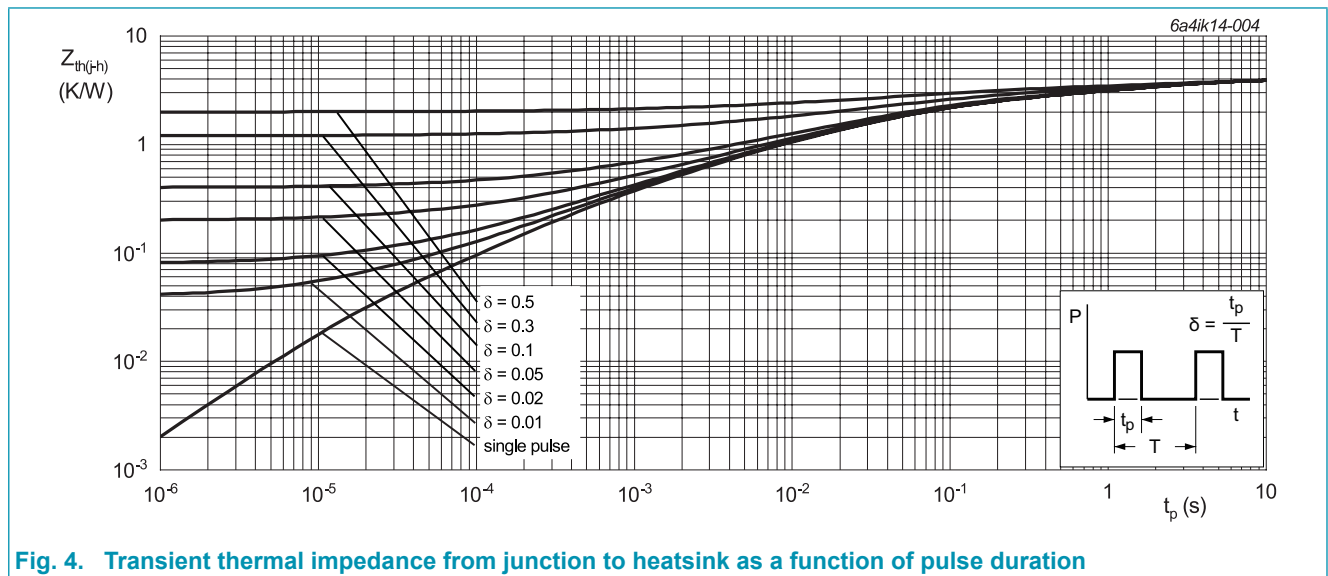


Fig. 4. Transient thermal impedance from junction to heatsink as a function of pulse duration

10. Isolation characteristics

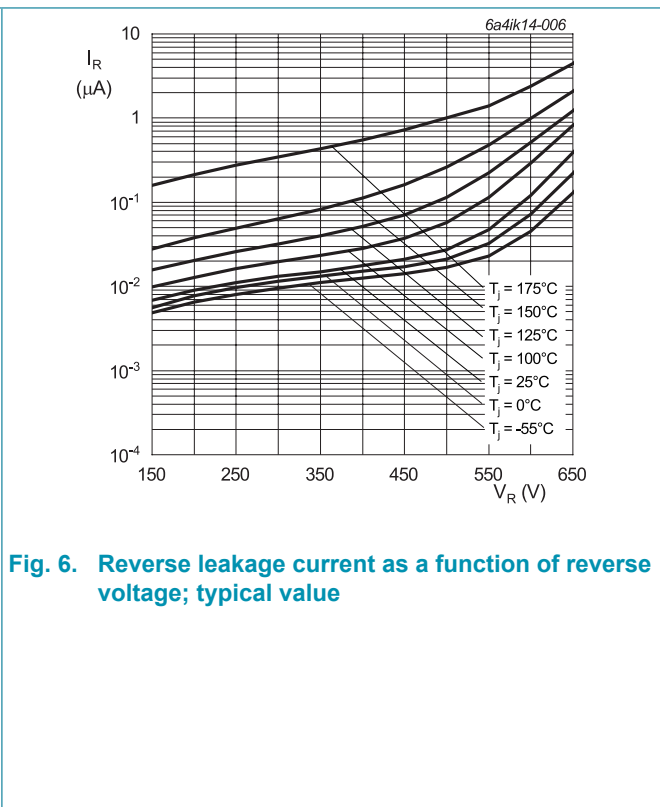
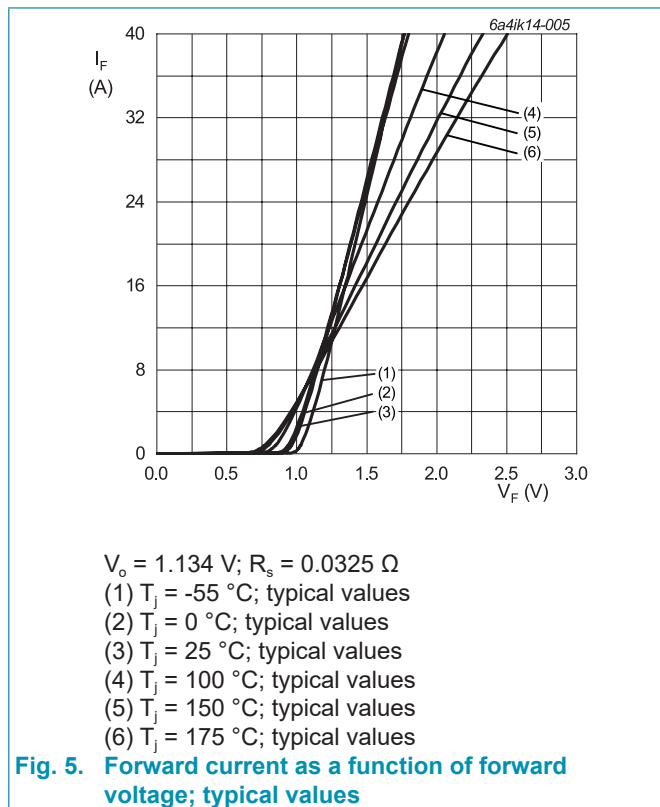
Table 7. Isolation characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$V_{isol(RMS)}$	RMS isolation voltage	from all terminals to external heatsink; sinusoidal waveform; clean and dust free; $50\text{ Hz} \leq f \leq 60\text{ Hz}$; $T_h = 25\text{ }^\circ\text{C}$; $RH \leq 65\%$		-	-	2500	V

11. Characteristics

Table 8. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V_F	forward voltage	$I_F = 16\text{ A}; T_J = 25\text{ }^\circ\text{C}; \text{Fig. 5}$		-	1.29	1.45	V
		$I_F = 16\text{ A}; T_J = 150\text{ }^\circ\text{C}; \text{Fig. 5}$		-	1.45	1.65	V
		$I_F = 16\text{ A}; T_J = 175\text{ }^\circ\text{C}; \text{Fig. 5}$		-	1.50	1.70	V
I_R	reverse current	$V_R = 650\text{ V}; T_J = 25\text{ }^\circ\text{C}; \text{Fig. 6}$		-	1	80	μA
		$V_R = 650\text{ V}; T_J = 175\text{ }^\circ\text{C}; \text{Fig. 6}$		-	25	320	μA
Dynamic characteristics							
Q_r	recovered charge	$I_F = 16\text{ A}; V_R = 400\text{ V}; dI_F/dt = 500\text{ A}/\mu\text{s}; T_J = 25\text{ }^\circ\text{C}; \text{Fig. 7}$		-	36	-	nC
C_d	diode capacitance	$f = 1\text{ MHz}; V_R = 1\text{ V}; T_J = 25\text{ }^\circ\text{C}$		-	860	-	pF
		$f = 1\text{ MHz}; V_R = 300\text{ V}; T_J = 25\text{ }^\circ\text{C}$		-	90	-	pF
		$f = 1\text{ MHz}; V_R = 600\text{ V}; T_J = 25\text{ }^\circ\text{C}$		-	80	-	pF
E_{as}	non-repetitive avalanche energy	$I_R = 7\text{ A}; T_{j(\text{init})} = 25\text{ }^\circ\text{C}; L = 5\text{ mH}$		120	-	-	mJ



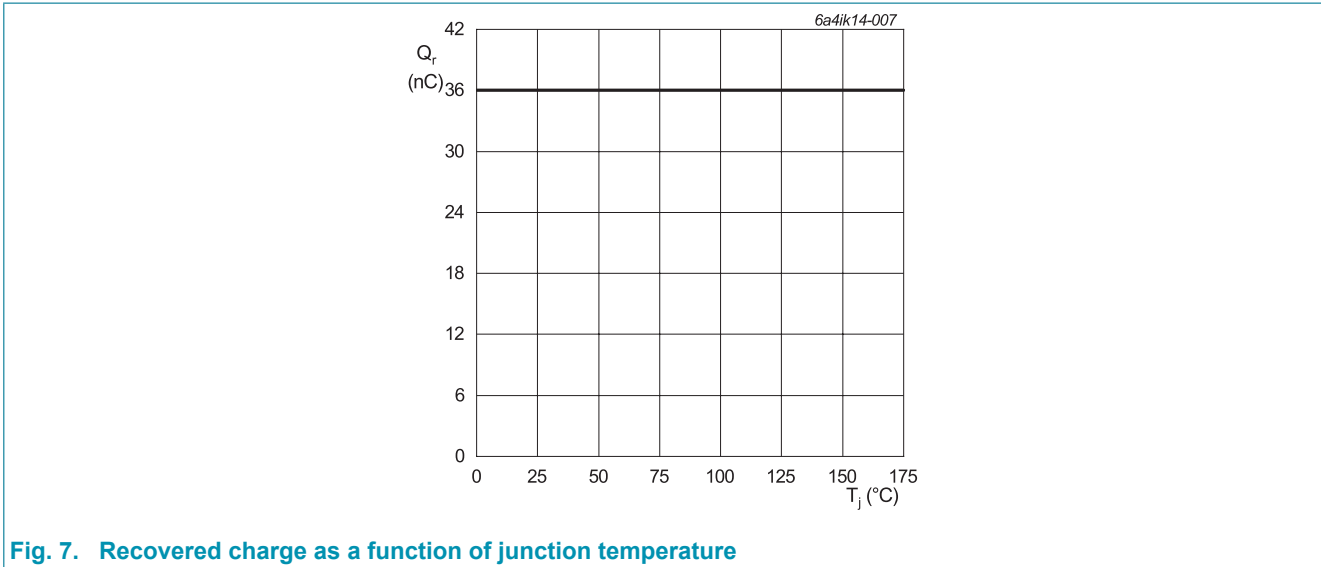
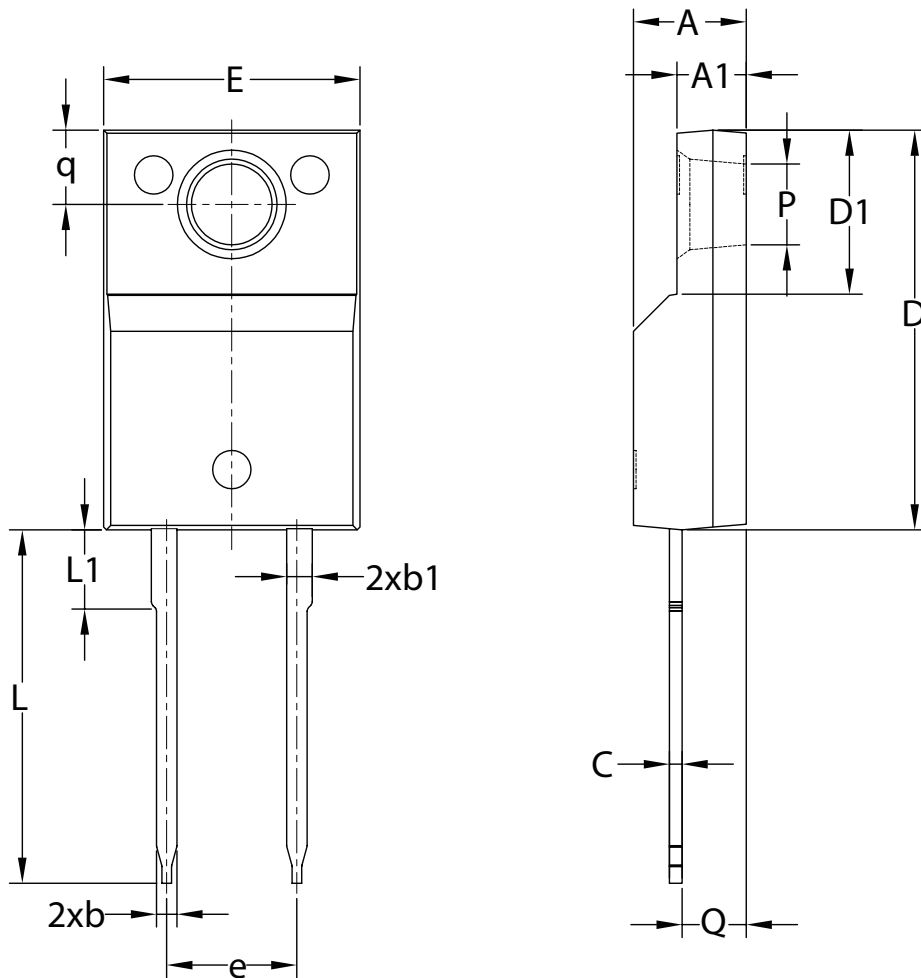


Fig. 7. Recovered charge as a function of junction temperature

12. Package outline

Plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 2 leads TO-220 'full pack' TO220F-2L



Unit	A	A1	b	b1	c	D	D1	E	e	L	L1	P	Q	q
MM	min	4.20	2.50	0.70	0.90	15.40	6.00	9.70	5.08 (BSC)	13.50	2.80	3.00	2.30	2.60
	max	4.60	2.90	0.90	1.30	15.80	6.40	10.30		14.40	3.30	3.30	2.60	3.00

13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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